

### AMPMODU | AMPMODU Headers

TE Internal #: 87224-5 PCB Mount Header, Vertical, Board-to-Board, 5 Position, 2.54 mm [. 1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



### EU RoHS Compliance: Compliant

EU ELV Compliance: Compliant

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

### Features

#### Other

EU RoHS Compliance

EU ELV Compliance

Compliant

Compliant

### Product Type Features

PCB Connector Assembly Type	PCB Mount Header	
Connector System	Board-to-Board	
Header Type	Unshrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
Board-to-Board Configuration	Parallel	
PCB Mount Orientation	Vertical	
Number of Positions	5	
Number of Rows	1	
Electrical Characteristics		
Insulation Resistance	5000 ΜΩ	
Dielectric Withstanding Voltage (Max)	750 Vrms	
Body Features		

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Primary Product Color	Black
Contact Features	
Contact Underplating Material	Nickel
Contact Mating Area Plating Material Thickness	.38 µm[15 µin]
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Square
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Gold Flash
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Termination Post & Tail Length	3.18 mm[.125 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to PCB	Through Hole - Solder
Mechanical Attachment	
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
PCB Thickness (Recommended)	1.4 mm[.055 in]
Jsage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]
Operation/Application	
Circuit Application	Signal
ndustry Standards	
Compatible With Agency/Standards Products	UL, CSA
+1 800 522 6752	12/10/2024 (

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Compatible With Approved Standards Products	UL E28476, CSA LR7189	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	520	
Packaging Method	Carton	
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC	
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.	
Solder Process Capability	Wave solder capable to 240°C	

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## **Compatible Parts**

PCB Mount Header, Vertical, Board-to-Board, 5 Position, 2.54 mm [.1 in] Centerline, Unshrouded, Gold, Through Hole - Solder, Signal, AMPMODU Headers





# Also in the Series AMPMODU Headers



# Customers Also Bought



TE Part #350793-1TE Part #87224-304P UMNL PIN HDR ASSY 94VO03 MODII HDR SRST UNSHRD .100	TE Part #87224-2 02 MODII HDR SRST UNSHRD .100	TE Part #5-534206-5 10 MODII VRT DR CE 100/115
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TE Part #CONMCX012-R178 MCX Plug 50 Ohm Cable Crimp



TE Part #CONMMCX012-R178 MMCX Jack 50 Ohm Cable Crimp





TE Part #953363-1 6pos MQS .63 header 180deg



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### Documents

Product Drawings 05 MODII HDR SRST UNSHRD .100

English

### CAD Files

Customer View Model

ENG\_CVM\_87224-5\_L.3d\_stp.zip

English

Customer View Model

ENG\_CVM\_87224-5\_L.2d\_dxf.zip

English

3D PDF

English

Customer View Model

ENG\_CVM\_87224-5\_L.3d\_igs.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### Datasheets & Catalog Pages AMPMODU\_INTERCONNECTION\_SYSTEM\_SECTION5

English